A Novel Robust RF-MEMS Varactor Design with Extended Tuning Range

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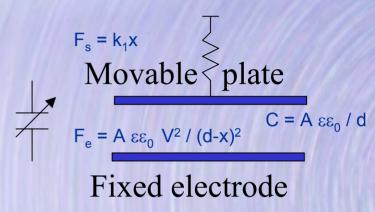
Presentation contents

- Varactor concept
- Requirements
- Design overview
- Simulations
- Preliminary experimental results
- Conclusions



General varactor concept

- Varactors can be built in MEMS technology as:
 - A capacitor where the gap distance is controlled by the motion of one of the parallel plates
 - Electrostatic actuation will be considered, as it does not require any static current consumption



 $\begin{array}{l} F_{s}-\text{restitution force}\\ k_{1}-\text{linear spring coefficient}\\ x-\text{displacement}\\ A-\text{capacitor area}\\ V-\text{Voltage across the capacitor}\\ d-\text{airgap distance} \end{array}$

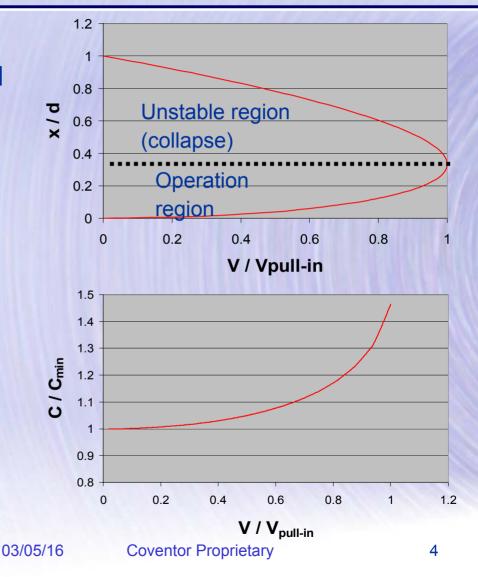


Plate collapse (pull-in)

- In linear electro-mechanical systems, equilibrium can only be reached for values x < d/3, the plate collapses after this value has been reached
- This limitation restricts the controllable capacitance change

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Maximum ratio is < 1.5



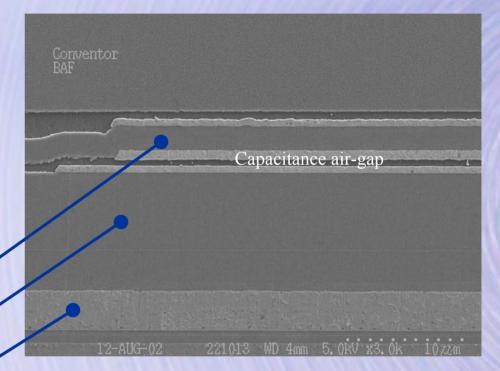
Requirements

- Process compatibility with Coventor RF-MEMS switch platform
- Design robust against fabrication tolerances
- Large capacitance tuning range
- Functional under normal operation conditions (temperature, acceleration, ...)
- Full electrical isolation between control- and RF- signals



Coventor switch process

- Varactor design should be compatible with our mature RF-MEMS switch process which includes:
 - A movable triple layer (metal-dielectric-metal)
 - Thick dielectric
 - Metal interconnection layers

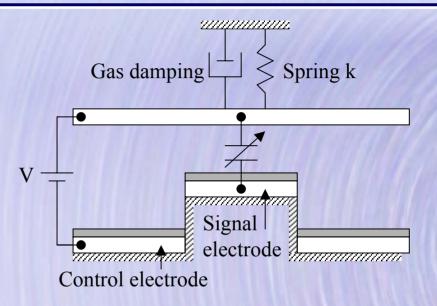




How to extend the displacement range?

 If signal voltage << control voltage, a <u>dual-gap</u> approach can be used:

Actuator air-gap should be > 3 times the capacitor air-gap

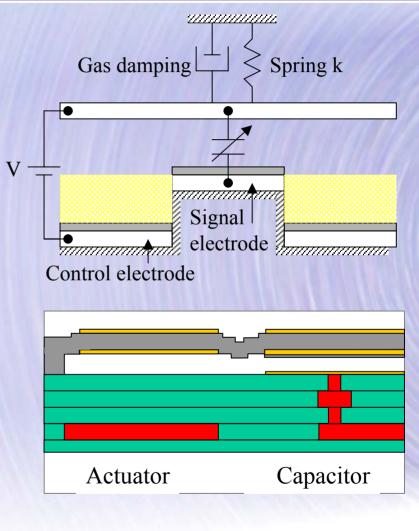


"Microelectromechanical capacitors for RF applications", H Nieminen, V Ermolov, K Nybergh, S Silanto and T Ryhänen, J. Micromech. Microeng. 12 (2002) 177–186



Quasi dual-gap

- If signal voltage << control voltage, a <u>dual-gap</u> approach can be used: Actuator air-gap should be > 3 times the capacitor air-gap
- <u>Quasi- dual</u> approach is equivalent, with a thick dielectric in the actuator gap





Design Overview

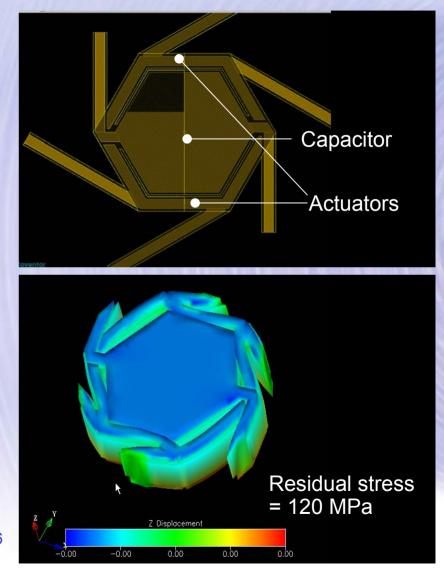
- A hexagonal shape was chosen for symmetry reasons.
- Separation of the signal capacitor and the actuator electrodes.
- Some mechanical isolation is provided by suspending the capacitor inside the actuated peripheral frame.
- The angle between the membranes and the tethers minimizes residual stress effects





Advantages of the hexagonal design

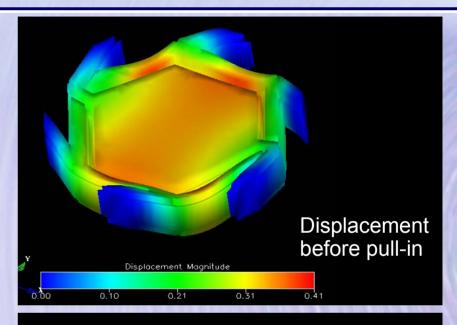
- The electrostatic force is well-distributed around the central capacitance plate
- Residual and thermal stresses have little influence on the zposition of the plate

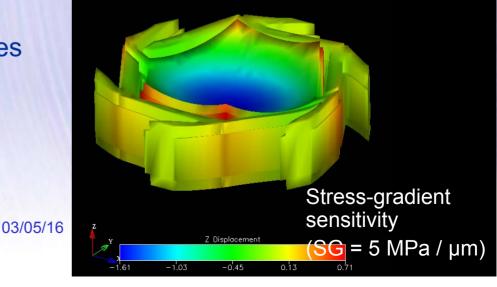


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Issues related to large areas

- Large structures (for increased capacitance) are too compliant for a proper 'parallel-plate' behavior
 - The capacitance area is deflected by almost half of the total displacement
- The large area also makes difficult to have flat structures in presence of stressgradients

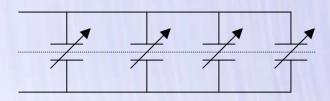


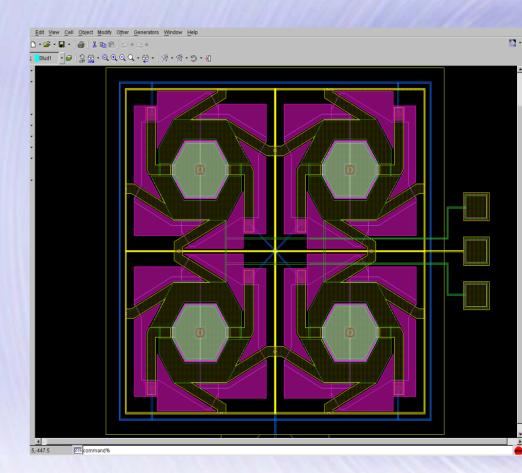




How to minimize area-related effects?

 A given capacitance value can be reached by using arrays of identical smaller capacitors







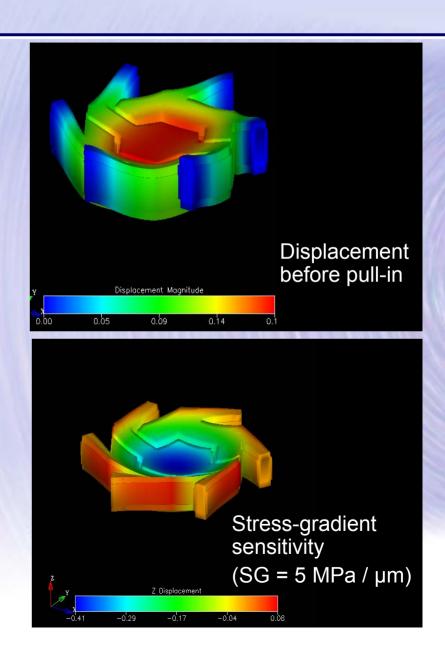
Area related-effects

- A flatter capacitor is obtained for a smaller device
 - The capacitance plate distorts only slightly

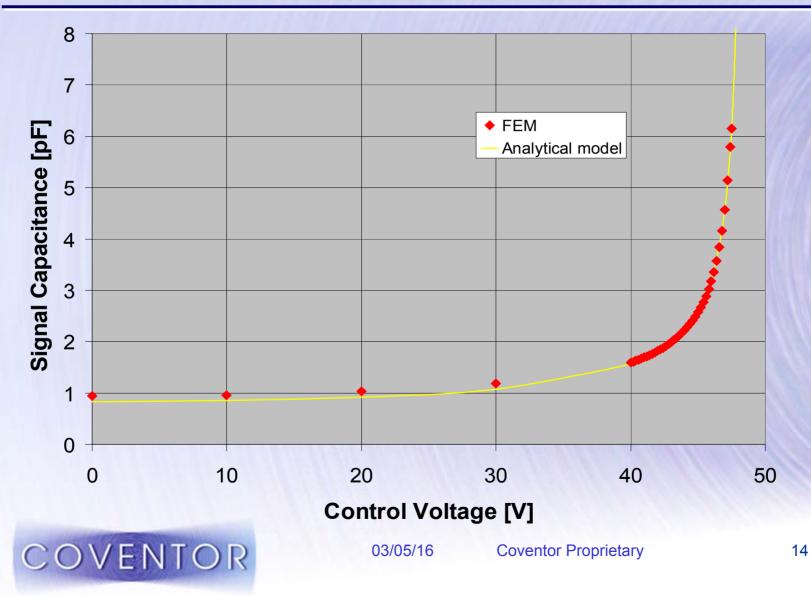
• The structure is also lesssensitive to stress-gradients

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Simulated C(V) curve



Simulation results

Characteristics	Value
C _{min}	0.9 pF
Capacitance ratio	> 1:5
Maximum Control Voltage	50 V
Mechanical resonance frequency	22 kHz
Vibration sensitivity	< 0.5% / g
Stress sensitivity (related to operating temperature)	negligible

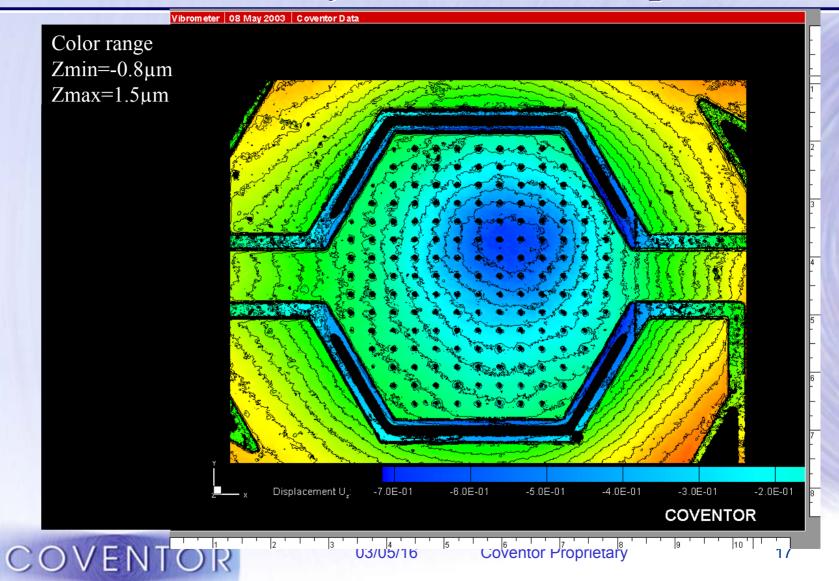


Preliminary experimental results

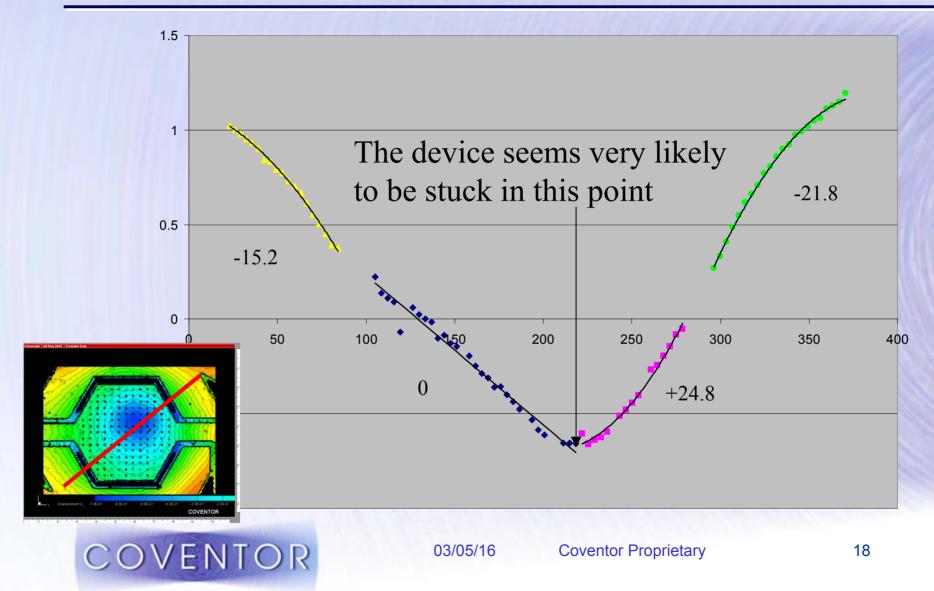
- Diced samples show stiction
- Undiced samples are released and are currently being measured



3D-Interferometry on a diced sample



Cutline (four sections)



Conclusions

- A concept and detailed design for a highperformance RF-MEMS varactor was presented
- The varactor has been fabricated in Coventor's RF-MEMS switch process
 - Dicing step is being currently improved
 - Measurements on un-diced samples are currently being completed

